DATASHEET

SMD Side View LEDs 99-616LM2C/L8287SGT2/TR8-T(SB)



Features

.Side view white LED.

.White SMT package.

.Lead frame package with individual 2 pins.

.Wide viewing angle

.Soldering methods: IR reflow soldering

.Pb-free

.The product itself will remain within RoHS compliant version.

.Compliance with EU REACH.

.Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

Due to the package design, BL-3806L has wide viewing angle, low power consumption and white LEDs are devices which are materialized by combing blue chips and special phosphor. This feature makes the LED ideal for light guide application.

Applications

.LCD back light.

.Mobile phones.

.Illuminations.

.Switch lights.

Coding:

99-616LM2C/LXX XX XX XX/TR8-T



Device Selection Guide

Chip	Emitted Color	Resin Color
Materials		
InGaN	Pure White	Water Clear

Phosphor Type Code

Code	Yellow Phosphor	
M2	562 Emitting WL	

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V _R	5	V	
Forward Current	I _F	30	mA	
Peak Forward Current (Duty 1/10 @10ms)	I _{FP}	60	mA	
Power Dissipation	P _d	110	mW	
Operating Temperature	T _{opr}	-40 ~ +85	C°	
Storage Temperature	T _{stg}	-40 ~ +90	C°	
	T _{sol}	Reflow Soldering : 260 °C for 10 sec.		
Soldering Temperature		Hand Soldering : 350 °C for 3 sec.		

Notes: *1The products are sensitive to static electricity and must be carefully taken when handling products.

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Flux	Φ	8.25		9.00	lm	I⊧=20mA
Forward Voltage	VF	2.75		3.35	volt	I⊧=20mA
Viewing Angle	20 1/2		120		deg	I⊧=20mA
Reverse Current	I _R			1	μΑ	V _R =5V

Notes:

1. Tolerance of Luminous Flux: ±5%.

2. Tolerance of Forward Voltage: ±0.05V.



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Bin Range of Luminous Flux

Condition	lm(Min.)	lm(Max.)	Unit	Condition
82	8.25	8.50		
85	8.50	8.75	lm	I _F =20mA
87	8.75	9.00		

Notes: Tolerance of Luminous Flux: ±5%.

Bin Range of Forward Voltage

Bin Code	Min.	Max.	Unit	Condition
5-1	2.75	2.85		
5-2	2.85	2.95		
6-1	2.95	3.05	Volt	I⊧=20mA
6-2	3.05	3.15		IF=20IIIA
7-1	3.15	3.25		
7-2	3.25	3.35	-	

Note: Tolerance of Forward Voltage: ± 0.05V



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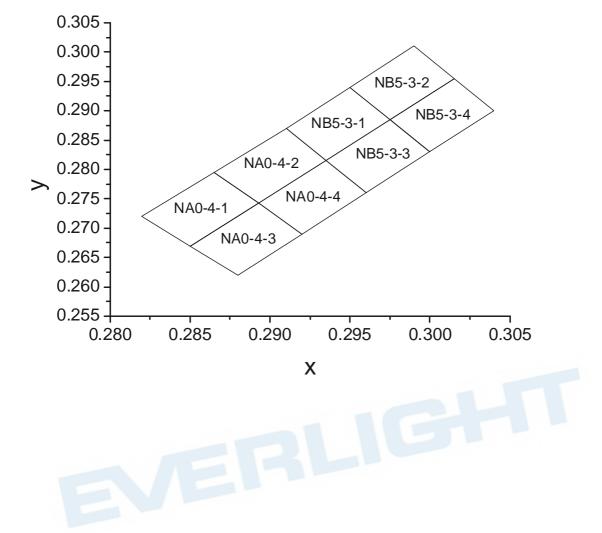
Bin Range of Chromaticity Coordinate

	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
	0.2850	0.2670		0.2893	0.2743
NA0-4-1	0.2820	0.2720	– – – – NA0-4-2 –	0.2865	0.2795
NAU-4-1	0.2865	0.2795	NAU-4-2 =	0.2910	0.2870
	0.2893	0.2743		0.2935	0.2815
	0.2880	0.2620		0.2920	0.2690
NAO 4 2	0.2850	0.2670		0.2893	0.2743
NA0-4-3	0.2893	0.2743	- NA0-4-4 -	0.2935	0.2815
	0.2920	0.2690		0.2960	0.2760
	0.2935	0.2815		0.2975	0.2885
	0.2910	0.2870		0.2950	0.2940
NB-5-3-1	0.2950	0.2940	– NB-5-3-2 –	0.2990	0.3010
	0.2975	0.2885		0.3015	0.2955
	0.2960	0.2760		0.3000	0.2830
	0.2935	0.2815		0.2975	0.2885
NB-5-3-3	0.2975	0.2885	– NB-5-3-4 –	0.3015	0.2955
	0.3000	0.2830		0.3040	0.2900

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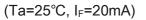


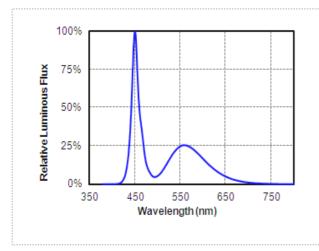
The C.I.E. 1931 Chromaticity Diagram



Typical Electro-Optical Characteristics Curves

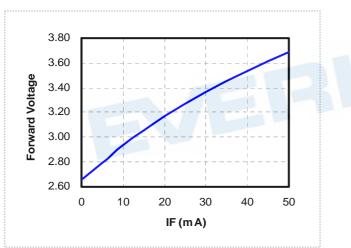
1. Spectrum Distribution



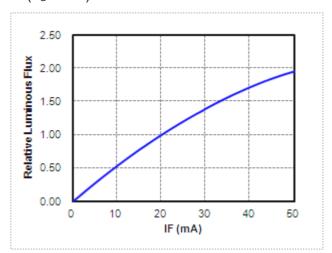


3. Relative Forward Voltage vs. Forward Current

(TA=25℃)

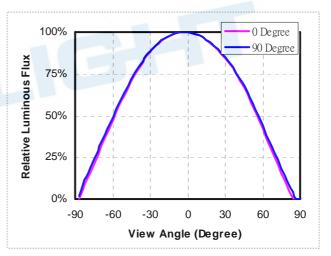


2. Relative Luminous Flux vs. Forward Current (T_a=25°C)



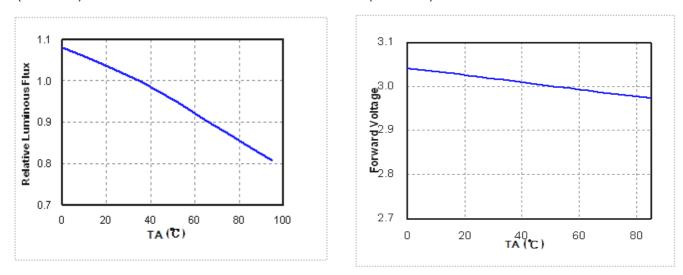
4. Radiation Diagram

(TA=25°C, IF=20mA)

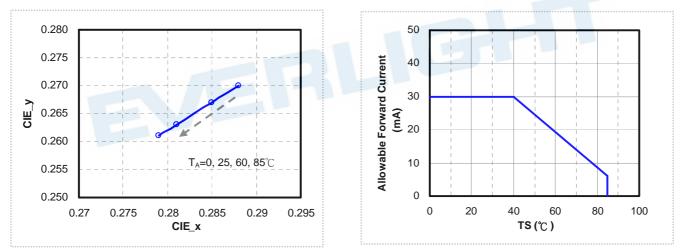


Typical Electro-Optical-Thermal Characteristics Curves

5. Relative Luminous Flux vs. Ambient Temperature 6. Forward Voltage vs. Ambient Temperature (I_F=20mA)

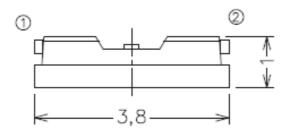


7. Chromaticity Coordinates vs. Ambient Temperature 8. Forward Current De-rating Curve (IF=20mA)

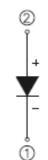


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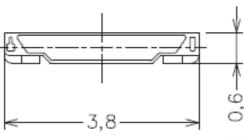
Package Dimension

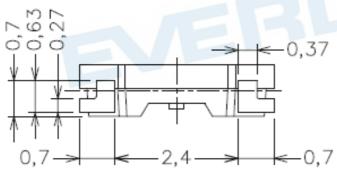






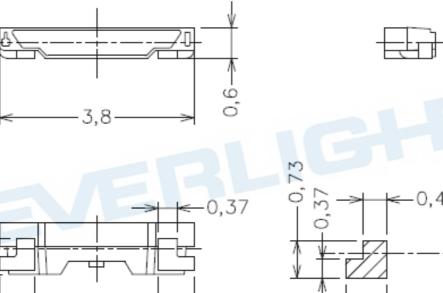
Polarity

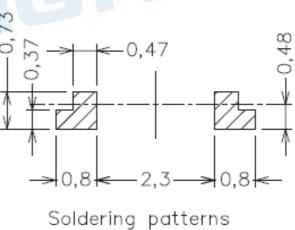




Bot. view

Note: Tolerances unless dimension are ± 0.1 mm, unit = mm.

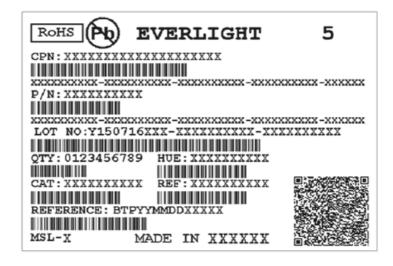


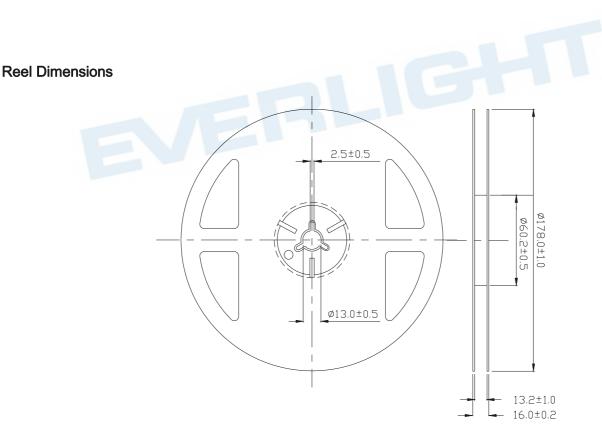


Moisture Resistant Packing Materials

Label Explanation

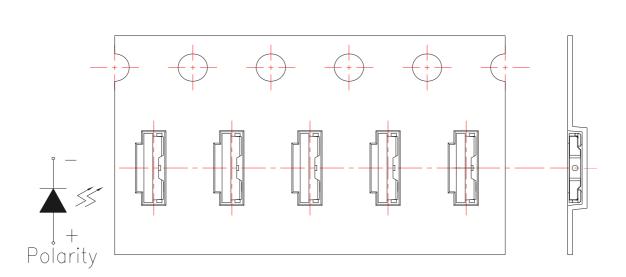
- ·CAT: Luminous Flux Rank
- ·HUE: Chromaticity Coordinates
- ·CPN: Customer's Product Number
- ·P/N: Product Number
- ·QTY: Packing Quantity
- ·CAT: Luminous Intensity Rank
- ·HUE: C.I.E Range Code Of Group
- ·REF: Forward Voltage Rank
- ·LOT No: Lot Number
- ·REF: Forward Voltage Rank





Note: The tolerances unless mentioned is ±0.1mm, Unit = mm

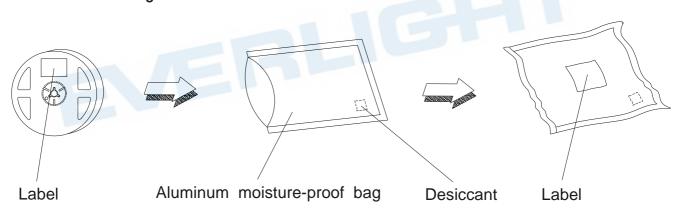
Carrier Tape Dimensions: Loaded Quantity 250 up/500/1000/2000/3000 pcs. Per Reel



Progressive direction

Note: Tolerance unless mentioned is ±0.1mm; Unit = mm

Moisture Resistant Packing Process



Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

		Test Condition	n Test Hours		Criteria			
NO	Item —	Temp./ Humidity	I _F (mA)	/ Times	lv @ 20mA	V _F @ 20mA		
1	Reflow Soldering	TSId = 260°C, Max	. 10sec.	2 times	<±10%	<±10%		
2	Temperature Cycle	-40°C ~ 30min. (5min.)	100°C 30min.	200 cycles				
3	Thermal Shock	-10°C ~ ~ 20min. (<15sec.)	100°C 20min.	200 cycles				
4	Low Temp. Storage	Ta= -40°C		1000 hrs				
5	High Temp. Storage	Ta= 100°C		1000 hrs				
6	Temp. Humidity Storage	Ta= 60°C/ 90%RH		1000 hrs		70%, 110%,		
7	Steady State Operating Life of Low Temp.	Ta= -40°C	20	1000 hrs	VFS	110%,		
8	Steady State Operating Life Condition 1	Ta= 25°C/ Room Humidity	20	1000 hrs				
9	Steady State Operating Life Condition 2	Ta= 60°C	20	1000 hrs	-			
10	Steady State Operating Life of High Temp.	Ta= 85°C	5	1000 hrs	-			
11	Steady State Operating Life of High Humidity Heat	Ta= 60°C/ 90%RH	20	1000 hrs				

Notes:

Sampling for each test item: 22 (pcs.)

Precautions for Use

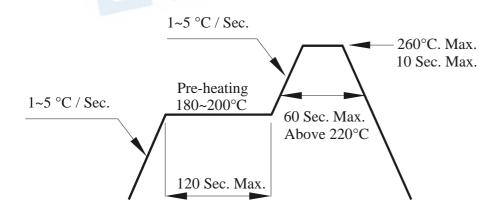
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be used within one year and kept at 30°C or less and 70%RH or less.

- 2.3 After opening the package: We recommend that the LED should be soldered quickly (within 3 days). The soldering condition is 30°C or less and 60%RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours. (One time only)
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in

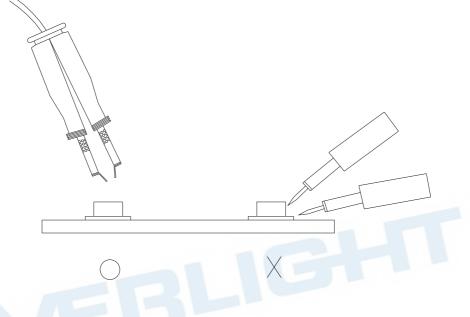
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less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6. Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound

单击下面可查看定价,库存,交付和生命周期等信息

>>Everlight(亿光)